WP132XSEC/J4-AMT

T-1 (3mm) Solid State Lamp

DESCRIPTIONS

- The Orange source color devices are made with AlGaInP Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- Low power consumption
- Popular T-1 diameter package
- General purpose leads
- Reliable and rugged
- Long life - solid state reliability
- Available on tape and reel
- RoHS compliant

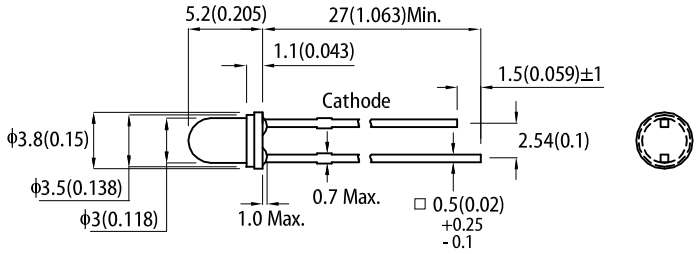
APPLICATIONS

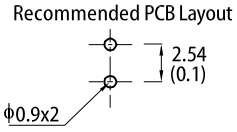
- Traffic signaling
- Backlighting (illuminated advertising , general lighting)
- Interior and exterior automotive lighting
- Substitution of micro incandescent lamps
- Reading lamps
- Signal and symbol luminaire for orientation
- Marker lights (e.g. Steps, exit ways, etc)
- Decorative and entertainment lighting
- Indoor and outdoor commercial and residential architectural lighting

ATTENTION

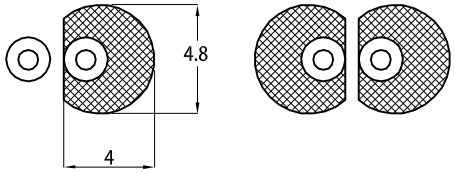
Observe precautions for handling electrostatic discharge sensitive devices

PACKAGE DIMENSIONS





RECOMMENDED SOLDERING PATTERN
(units : mm; tolerance : ± 0.1)



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA [2]			Viewing Angle [1]
			Code.	Min.	Max.	2θ1/2
WP132XSEC/J4-AMT	Super Bright Orange (AlGaInP)	Water Clear	Z	2700	3100	50°
			ZA	3100	3600	
			ZB	3600	4200	
			ZC	4200	5000	
			ZD	5000	6000	
			*Y	*2300	*2700	
			*Z	*2700	*3100	
			*ZA	*3100	*3600	
			*ZB	*3600	*4200	
			*ZC	*4200	*5000	

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.
** Luminous intensity value is traceable to CIE127-2007 standards.*

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value			Unit
			Min.	Typ.	Max.	
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	Super Bright Orange	-	611	-	nm
Dominant Wavelength I_F = 20mA	λ_{dom} [1]	Super Bright Orange	598	-	612	nm
Spectral Bandwidth at 50% Φ REL MAX I_F = 20mA	Δλ	Super Bright Orange	-	17	-	nm
Capacitance	C	Super Bright Orange	-	27	-	pF
Forward Voltage I_F = 20mA	V_F [2]	Super Bright Orange	-	2.2	2.8	V
Reverse Current (V_R = 5V)	I_R	Super Bright Orange	-	-	10	uA
Temperature Coefficient of λ_{peak} I_F = 20mA, -10°C ≤ T ≤ 85°C	$TC_{\lambda peak}$	Super Bright Orange	-	0.14	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 20mA, -10°C ≤ T ≤ 85°C	$TC_{\lambda dom}$	Super Bright Orange	-	0.04	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C ≤ T ≤ 85°C	TC_V	Super Bright Orange	-	-2.0	-	mV/°C

Notes:
1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

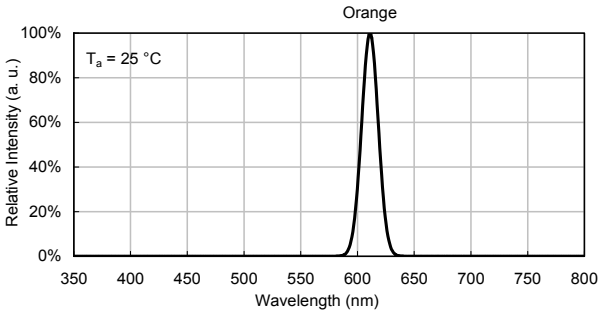
ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	140	mW
Reverse Voltage	V_R	5	V
Junction Temperature	T_j	115	°C
Operating Temperature	T_{op}	-40 to +100	°C
Storage Temperature	T_{stg}	-40 to +115	°C
DC Forward Current	I_F	50	mA
Peak Forward Current	I_{FM} [1]	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	V
Thermal Resistance (Junction / Ambient)	$R_{th\ JA}$ [2]	450	°C/W
Thermal Resistance (Junction / Solder point)	$R_{th\ JS}$ [2]	160	°C/W

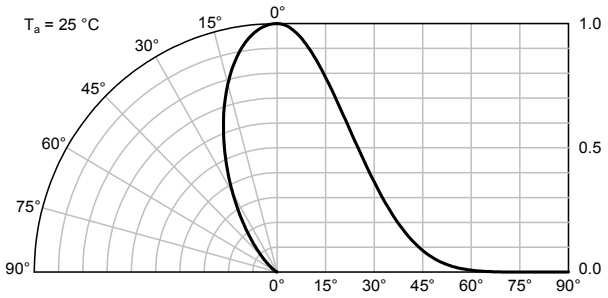
Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. $R_{th\ JA}$,$R_{th\ JS}$ Results from mounting on PC board FR4 (pad size ≥ 16 mm^2 per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

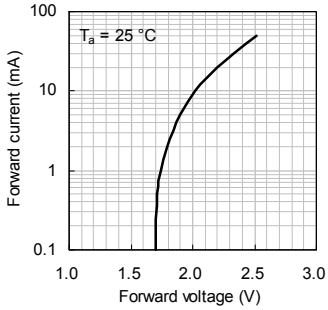


SPATIAL DISTRIBUTION

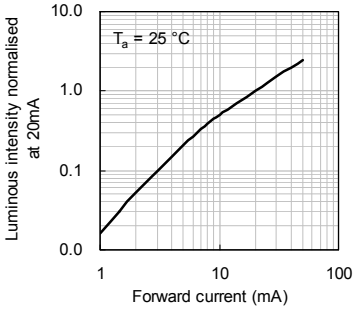


SUPER BRIGHT ORANGE

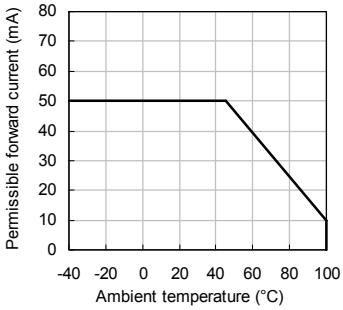
Forward Current vs. Forward Voltage



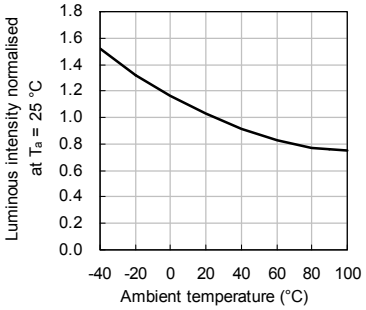
Luminous Intensity vs. Forward Current



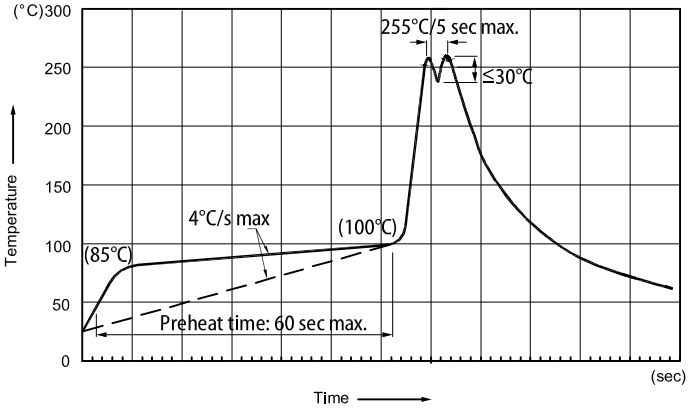
Forward Current Derating Curve



Luminous Intensity vs. Ambient Temperature

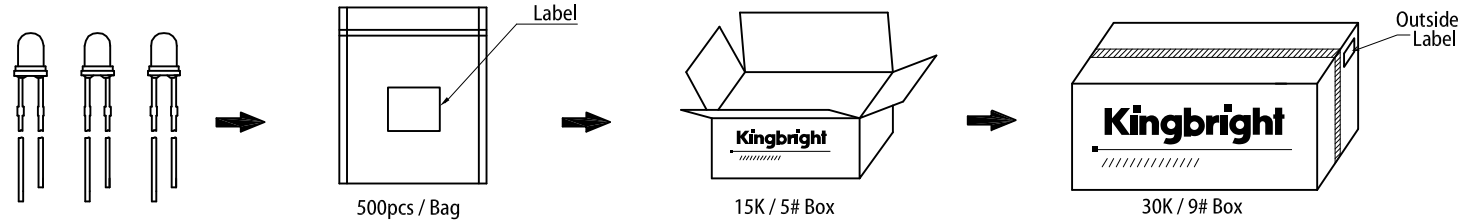


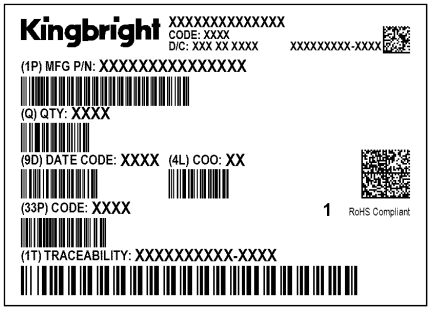
RECOMMENDED WAVE SOLDERING PROFILE



Notes:
1. *Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C*
2. *Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).*
3. *Do not apply stress to the epoxy resin while the temperature is above 85°C.*
4. *Fixtures should not incur stress on the component when mounting and during soldering process.*
5. *SAC 305 solder alloy is recommended.*
6. *No more than one wave soldering pass.*

PACKING & LABEL SPECIFICATIONS





PRECAUTIONS

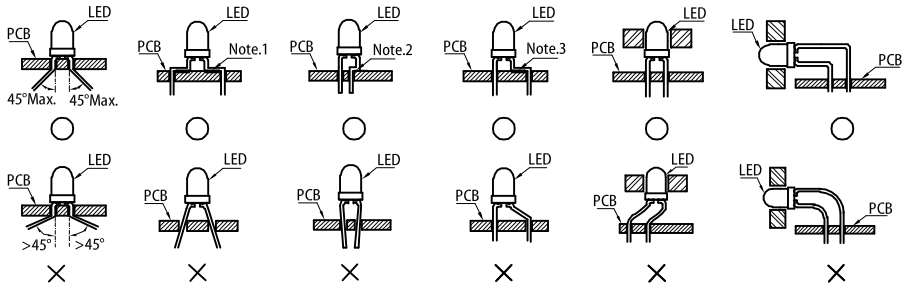
Storage conditions

1. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
2. LEDs should be stored with temperature ≤ 30°C and relative humidity < 60%.
3. Product in the original sealed package is recommended to be assembled within 72 hours of opening.
   Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85 ~ 100°C.

LED Mounting Method

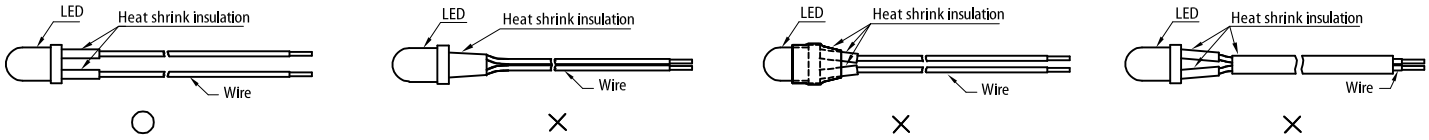
1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement.
   Lead-forming may be required to insure the lead pitch matches the hole pitch.
   Refer to the figure below for proper lead forming procedures.

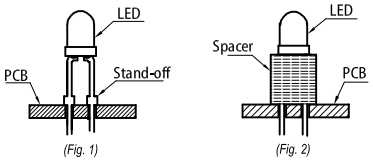
Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.



" ○ " *Correct mounting method* " x " *Incorrect mounting method*

2. When soldering wires to the LED, each wire joint should be separately insulated with heat-shrink tube to prevent short-circuit contact. Do not bundle both wires in one heat shrink tube to avoid pinching the LED leads. Pinching stress on the LED leads may damage the internal structures and cause failure.

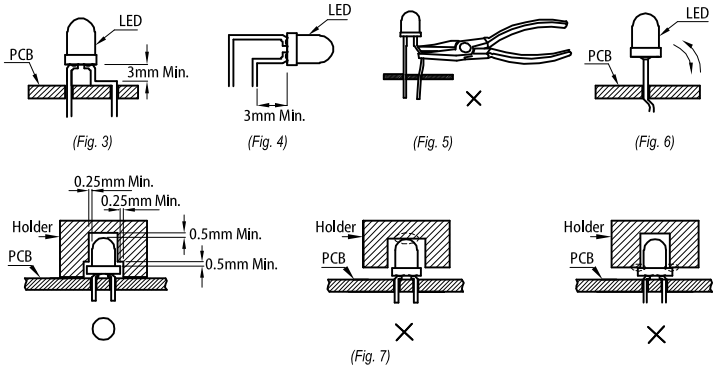




3. Use stand-offs *(Fig.1)* or spacers *(Fig.2)* to securely position the LED above the PCB.
4. Maintain a minimum of 3mm clearance between the base of the LED lens and the first lead bend *(Fig. 3 ,Fig. 4)*.
5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. *(Fig. 5)*

Lead Forming Procedures

1. Do not bend the leads more than twice. *(Fig. 6)*
2. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering. *(Fig. 7)*
3. The tip of the soldering iron should never touch the lens epoxy.
4. Through-hole LEDs are incompatible with reflow soldering.
5. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.



RELIABILITY TEST ITEMS AND CONDITIONS

The reliability of products shall be satisfied with items listed below

LOT TOLERANCE PERCENT DEFECTIVE (LTPD) : 10%

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	T_a = 25°C, I_F = maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100(101)	T_a = 100°C, I_F = derated current at 100°C	1,000 h	0 / 22
3	Low Temp. operating test	-	T_a = -40°C, I_F = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100(201)	T_a = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100(202)	T_a = -40°C	1,000 h	0 / 22
6	High temp. & humidity storage test	EIAJ ED-4701/100(103)	T_a = 60°C, RH = 90%	1,000 h	0 / 22
7	High temp. & humidity operating test	EIAJ ED-4701/100(102)	T_a = 60°C, RH = 90% I_F = derated current at 60°C	1,000 h	0 / 22
8	Resistance to Soldering Heat	EIAJ ED-4701/300 302	TSld=260±5°C, 10 sec	1 times	0 / 18
9	Thermal shock operating test	-	Ta = -40°C(15min) ~ 100°C(15min) IF = derated current at 100°C	500 cycles	0 / 22
10	Thermal shock test	-	T_a = -40°C(15min) ~ 100°C(15min)	500 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100(304)	C = 100pF, R2 = 1.5KΩ V = 3000V	Once each Polarity	0 / 22
12	Vibration test	-	a = 196m/s², f = 100~2KHz, t = 48min for all xyz axes	4 times	0 / 22

** : Refer to forward current vs. derating curve diagram*

FAILURE CRITERIA

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	I_V	I_F = 20mA	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V_F	I_F = 20mA	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I_R	V_R = Maximum Rated Reverse Voltage	Testing Max. Value ≥ Spec. Max. Value x 2.5
High temp. storage test	-	-	Occurrence of notable decoloration, deformation and cracking

PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
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